ABSTRACT OF THE DISCLOSURE

MAGNETIC HEAD APPARATUS WITH HEAD IC CHIP

A magnetic head apparatus includes a slider with at least one magnetic head element, a suspension having one end portion, one surface and connection pads formed on the one surface, for supporting the slider at the one end portion, a head IC chip flip chip bonded on the connection pads, and an overcoat layer formed on the one surface of the suspension to cover at least a part of each of the connection pads, the overcoat layer with anti-running structures for controlling flow of solder while the IC chip is flip chip bonded.

This Sheet Has Been Replaced

